Amendments to the Claims

This listing of claims will replace all prior versions, and listings, of claims in the application.

Listing of Claims:

1. (Currently Amended) An optical element module comprising:

a base part to which in which a groove is formed, a predetermined reference optical axis

[[is]] being relatively fixed to said base part in said groove;

an optical element positioned with respect to said reference optical axis, being out of contact with said groove base part; and

solder interposed between said optical element and said groove base part, for fixing said optical element onto said base part.

- (Original) The optical element module according to claim 1, wherein said base part is a part which is fixed to another optical element which determines said reference optical axis.
 - 3. (Original) The optical element module according to claim 2, wherein said optical element is a collimator lens.
 - 4. (Original) The optical element module according to claim 3, wherein said another optical element is a semiconductor light emitting element.
 - 5-8. (Cancelled)

9. (Original) An optical element module comprising:

a base part to which a plurality of reference optical axes are relatively fixed;

a plurality of optical elements which are positioned with respect to said plurality of reference optical axes, respectively, being out of contact with said base part; and

solder interposed between each of said plurality of optical elements and said base part, for fixing each of said optical elements to said base part.

- 10. (Original) The optical element module according to claim 9, wherein each of said plurality of optical elements is an optical fiber.
- 11. (Original) The optical element module according to claim 9, wherein said plurality of reference optical axes are respective axes of lenses in a microlens array.
- 12. (Withdrawn) An apparatus for fixing an optical element onto a base part, comprising:

a holding part for holding a base part to which a bonding agent for fixing a first optical element is applied;

a supporting part which supports said first optical element while moving the same to said base part and is removed from said first optical element after fixing;

a light receiving part for receiving a reference light emitted from said first optical element or a second optical element attached onto said base part;

a mechanism for moving or rotating said supporting part relatively to said holding part; and

a control part for positioning said first optical element at a position with respect to said second optical element on the basis of an output from said light receiving part.

- 13. (Withdrawn) The apparatus according to claim 12, wherein said control part controls a position of said first optical element in course of hardening of said bonding agent.
 - 14. (Withdrawn) The apparatus according to claim 12, wherein said first optical element is a collimator lens.
- 15. (Withdrawn) The apparatus according to claim 14, wherein said second optical element is a semiconductor light emitting element for emitting light towards said collimator lens.
 - 16. (Withdrawn) The apparatus according to claim 12, wherein said first optical element is a microlens array.
- 17. (Withdrawn) The apparatus according to claim 16, wherein said second optical element is an optical waveguide element for emitting lights towards said microlens array.

18. (Withdrawn) The apparatus according to claim 16, wherein

said second optical element is a semiconductor light emitting element for emitting a light towards said microlens array.

19. (Withdrawn) The apparatus according to claim 12, wherein said first optical element is an optical fiber.

20. (Withdrawn) The apparatus according to claim 12, further comprising

a switching lens which is movable to and fro on an optical path, between said light receiving part and a front optical element that is one of said first and second optical elements which is closer to said light receiving part,

wherein said front optical element is a lens and said front optical element and a light receiving surface in said light receiving part are optically conjugate to each other in a state where said switching lens is disposed on said optical path.

21. (Withdrawn) An apparatus for fixing an optical element onto a base part, comprising:

a holding part for holding a base part to which a bonding agent for bonding an optical element is applied;

a supporting part which supports said optical element while moving the same to said base part and is removed from said optical element after fixing; and

a moving mechanism for moving or rotating said supporting part relatively to said holding part with respect to at least three axes.

- 22. (Withdrawn) The apparatus according to claim 21, wherein said moving mechanism moves said supporting part relatively to said holding part along three motion axes and rotates said supporting part relatively to said holding part around three rotation axes.
- 23. (Withdrawn) The apparatus according to claim 21, wherein said optical element is one selected out of a group consisting of a semiconductor light emitting element, a collimator lens, a microlens array and an optical fiber.
- 24. (Withdrawn) The apparatus according to claim 21, further comprising a temperature control part for controlling temperature of said supporting part, wherein said supporting part supports said optical element with solder interposed therebetween.
- 25. (Withdrawn) The apparatus according to claim 21, wherein said bonding agent is a bonding agent containing resin component, and said apparatus further comprising a mechanism for hardening said bonding agent on said base part.
 - 26. (Withdrawn) The apparatus according to claim 21, wherein

said bonding agent is glass powder or solder, and
said apparatus further comprising
another temperature control part for controlling temperature of said holding part.

27. (Withdrawn) An apparatus for fixing an optical element onto a base part, comprising:

a holding part for holding a base part to which a bonding agent for fixing an optical element is applied;

a supporting part which supports said optical element while moving the same to said base part and is removed from said optical element after fixing;

a light receiving part for receiving a reference light emitted from said optical element;

a mechanism for moving or rotating said supporting part relatively to said holding part;

a control part for positioning said optical element at a position with respect to said base part on the basis of an output from said light receiving part.

28. (Withdrawn) A method of fixing an optical element onto a base part, comprising the steps of:

supporting a first optical element by a supporting part and positioning said first optical element at a predetermined position with respect to a base part;

receiving a reference light by a light receiving part, said reference light being emitted from said first optical element or a second optical element attached onto said base part;

positioning said first optical element at a position with respect to said second optical element on the basis of an output from said light receiving part;

fixing said first optical element onto said base part with a bonding agent; and removing said supporting part from said first optical element after fixing.

- 29. (Withdrawn) The method according to claim 28, wherein
- a position of said first optical element is controlled in course of hardening of said bonding agent in said step of fixing.
- 30. (Withdrawn) A method of fixing an optical element onto a base part, comprising the steps of:

supporting an optical element by a supporting part and moving or rotating said optical element with respect to at least three axes to position said optical element at a predetermined position relatively to a base part;

fixing said optical element onto said base part with a bonding agent; and removing said supporting part from said optical element after fixing.

- 31. (New) The optical element module according to claim 1, wherein said solder is interposed between at least both of opposite sides of said optical element and said groove with respect to said reference optical axis.
 - 32. (New) The optical element module according to claim 12, wherein

said solder is interposed between more than half of an outer peripheral surface of said optical element and said groove.

33. (New) The optical element module according to claim 1, wherein said optical element has a cylindrical outer peripheral surface.

34. (New) The optical element module according to claim 14, wherein said groove has a U-shaped section.